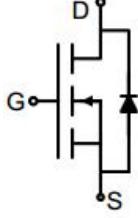
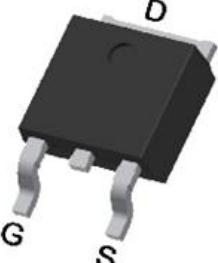


N-Channel Enhancement Mode Power MOSFET

<p>Description</p> <p>The GT10N10 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.</p> <p>General Features</p> <ul style="list-style-type: none"> ● V_{DS} 100V ● I_D (at $V_{GS} = 10V$) 7A ● $R_{DS(ON)}$ (at $V_{GS} = 10V$) < 140mΩ ● $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) < 175mΩ ● 100% Avalanche Tested ● RoHS Compliant <p>Application</p> <ul style="list-style-type: none"> ● Power switch ● DC/DC converters 	 <p>Schematic diagram</p>  <p>TO-252</p>
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Ordering Information			
Device	Package	Marking	Packaging
GT10N10	TO-252	GT10N10	2500pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted			
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Continuous Drain Current	I_D	7	A
Pulsed Drain Current (note1)	I_{DM}	21	A
Gate-Source Voltage	V_{GS}	± 20	V
Power Dissipation	P_D	17	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	°C

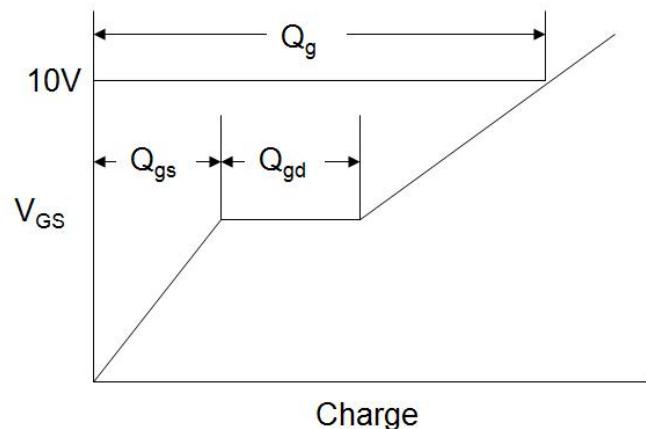
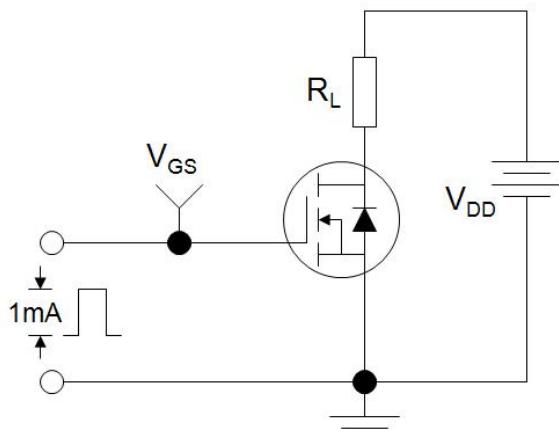
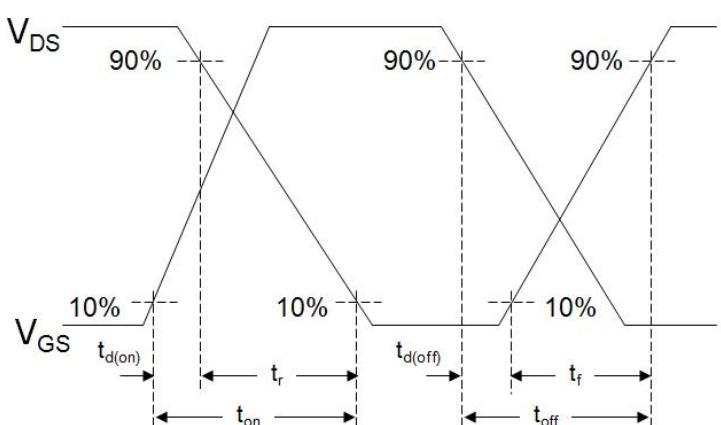
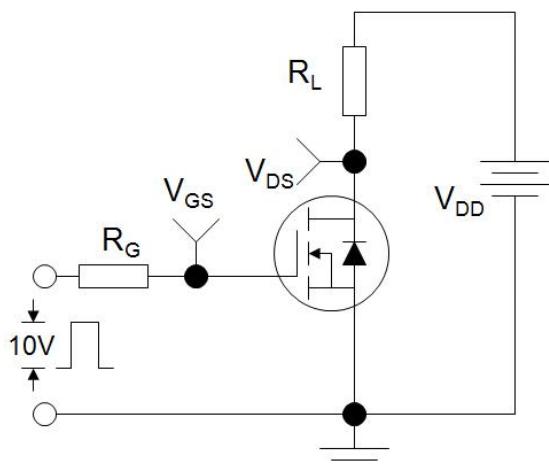
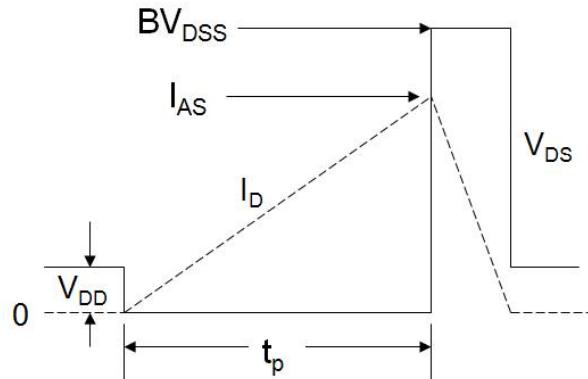
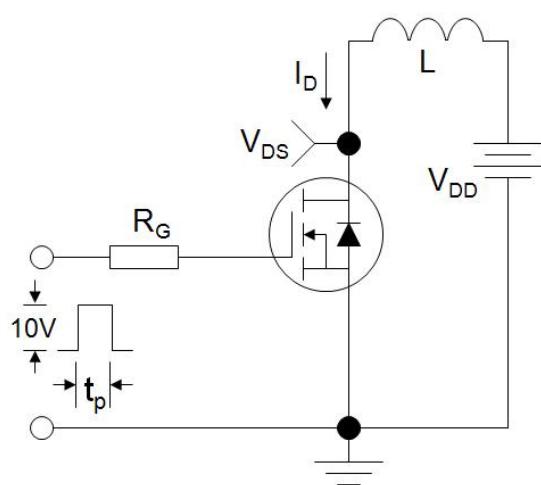
Thermal Resistance			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	50	°C/W
Maximum Junction-to-Case	R_{thJC}	7.4	°C/W

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.5	2	2.5	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 3.5\text{A}$	--	115	140	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 3.5\text{A}$	--	150	175	
Forward Transconductance	g_{FS}	$V_{\text{GS}} = 15\text{V}, I_D = 2\text{A}$	3	--	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 50\text{V}, f = 1.0\text{MHz}$	--	206	--	pF
Output Capacitance	C_{oss}		--	28.9	--	
Reverse Transfer Capacitance	C_{rss}		--	1.4	--	
Total Gate Charge	Q_g	$V_{\text{DD}} = 50\text{V}, I_D = 3.5\text{A}, V_{\text{GS}} = 10\text{V}$	--	4.3	--	nC
Gate-Source Charge	Q_{gs}		--	1.5	--	
Gate-Drain Charge	Q_{gd}		--	1.1	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 50\text{V}, I_D = 3.5\text{A}, R_G = 2\Omega$	--	14.7	--	ns
Turn-on Rise Time	t_r		--	3.5	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	20.9	--	
Turn-off Fall Time	t_f		--	2.7	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	7	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 3.5\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	Q_{rr}	$I_F = 3.5\text{A}, V_{\text{GS}} = 0\text{V}$ $dI/dt=500\text{A}/\mu\text{s}$	--	52	--	nC
Reverse Recovery Time	T_{rr}		--	16	--	ns

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

Gate Charge Test Circuit**Switch Time Test Circuit****EAS Test Circuit**

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

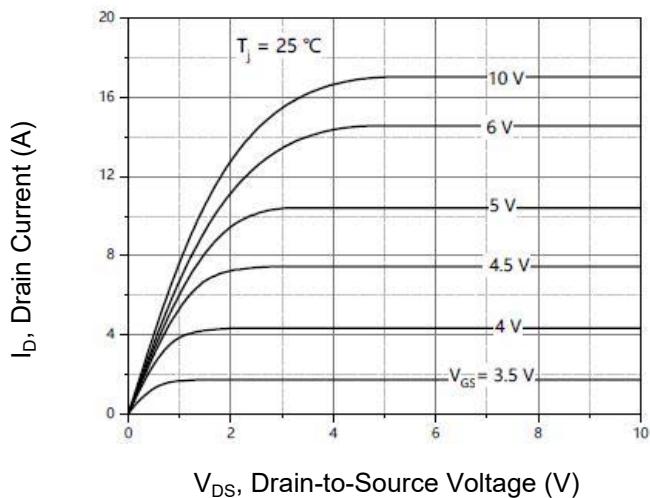


Figure 2. Transfer Characteristics

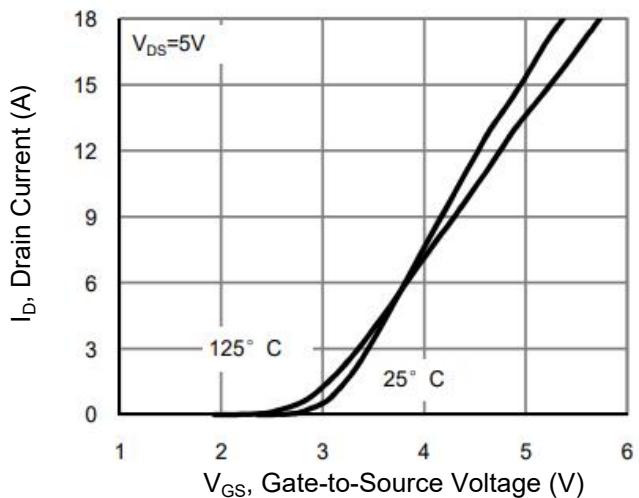


Figure 3. Drain Source On Resistance

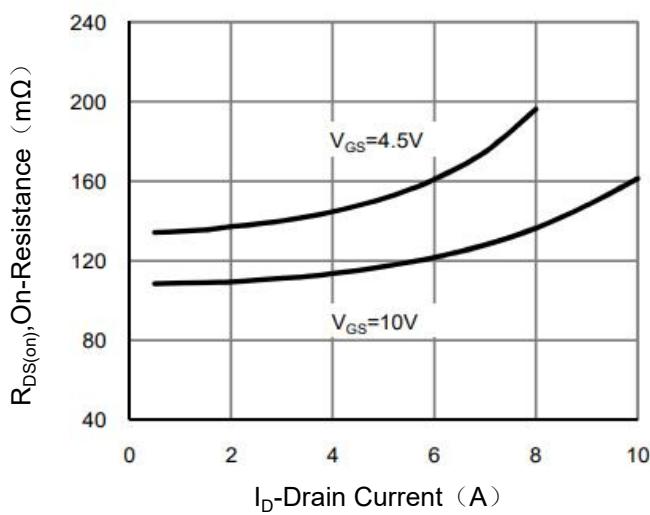


Figure 4. Gate Charge

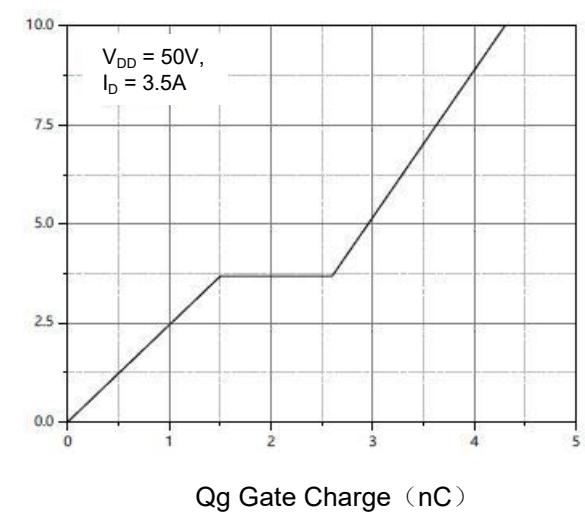


Figure 5. Capacitance

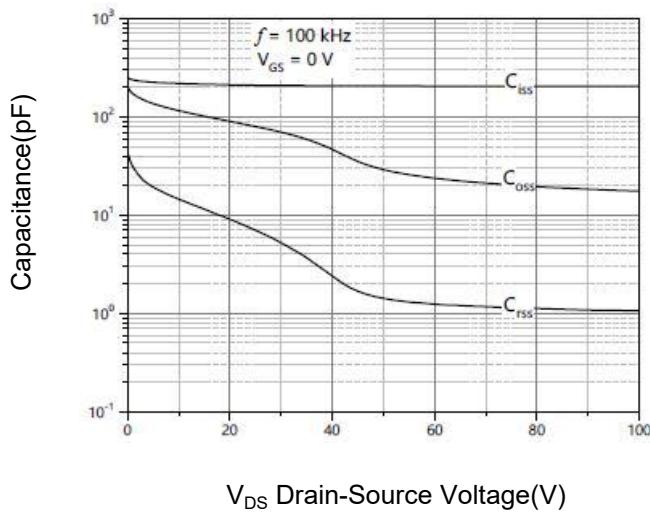
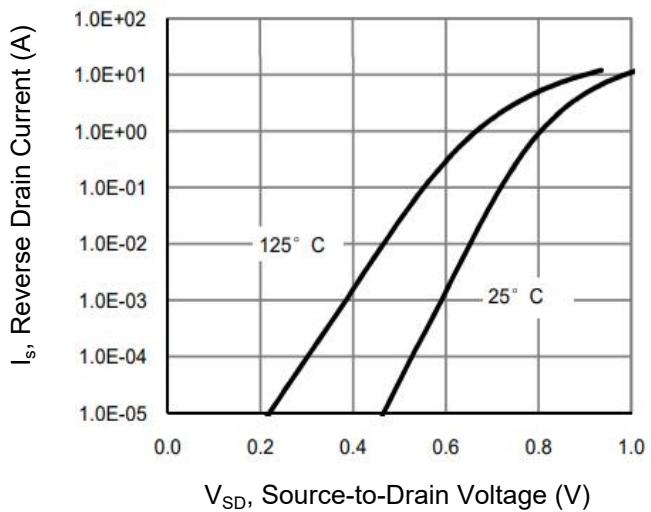


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

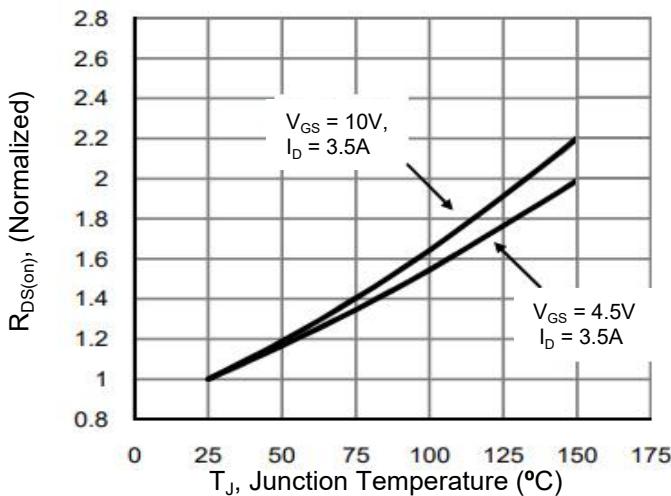


Figure 8. Safe Operation Area

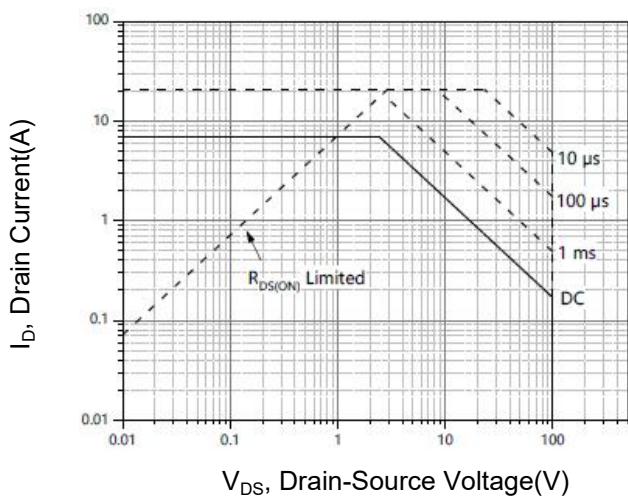
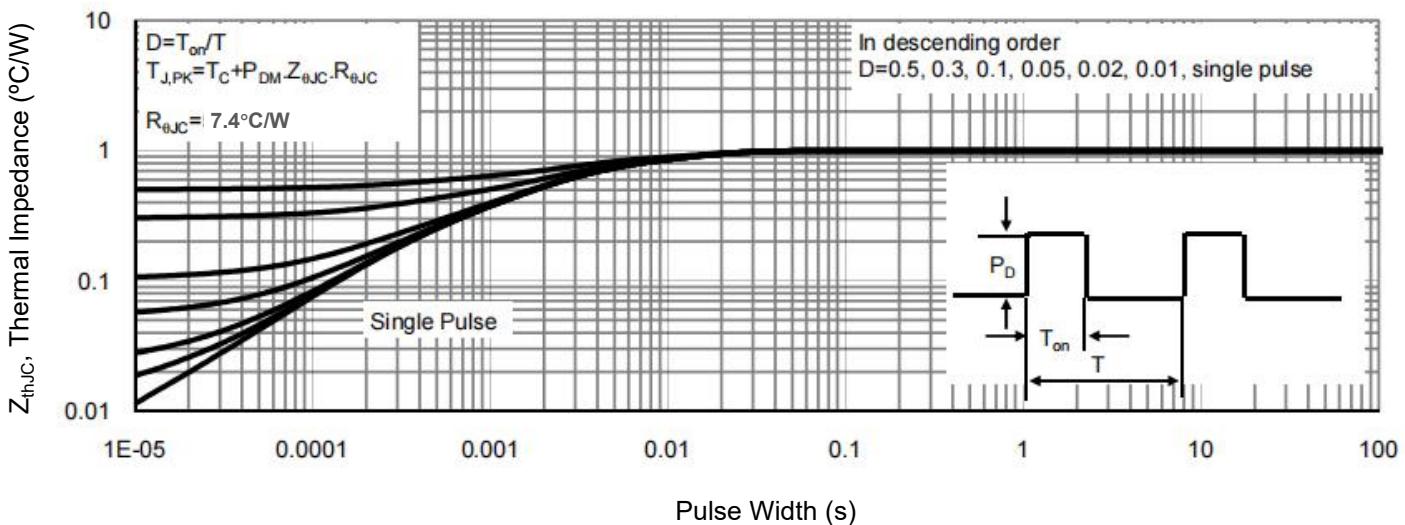
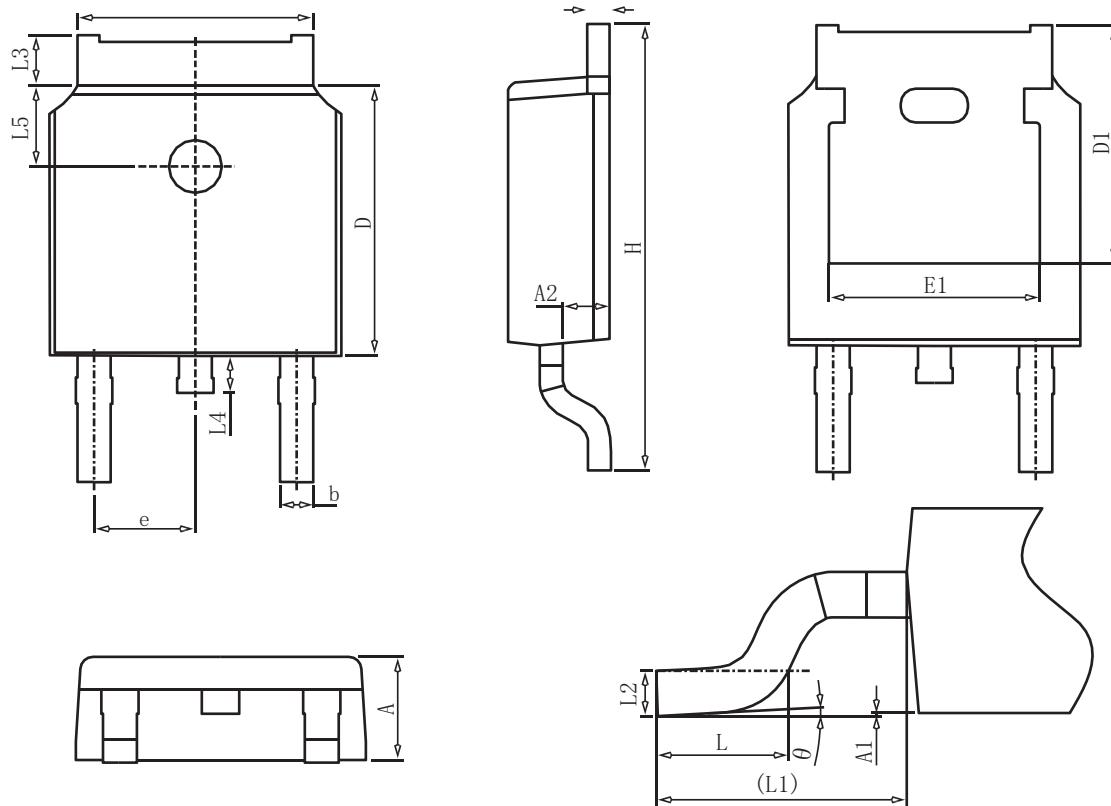


Figure 9. Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	-	0.20
A2	0.97	1.07	1.17
b	0.68	0.78	0.90
b3	5.20	5.33	5.50
c	0.43	0.53	0.63
D	5.98	6.10	6.22
D1		5.30REF	
E	6.40	6.60	6.80
E1	4.63	-	-
e		2.286BSC	
H	9.40	10.10	10.50
L	1.38	1.50	1.75
L1		2.90REF	
L2		0.51BSC	
L3	0.88	-	1.28
L4	0.50	-	1.00
L5	1.65	1.80	1.95
θ	0°	-	8°